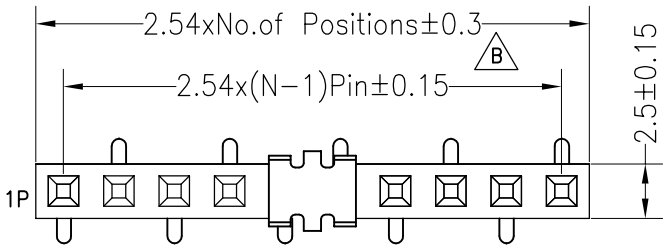
HSF RoHS

FILE NO :E362810

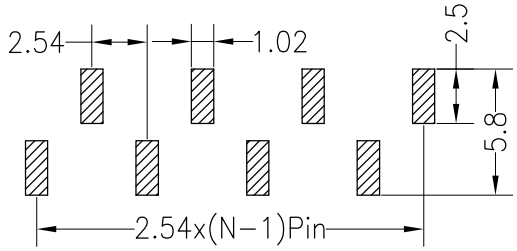
SPECIFICATIONS
Rated Current:3.0AMP
Contact Resistance:20mΩ Max
Withstand Voltage:1000V AC/DC
Insulation Resistance:1000MΩ Min
Operation Temperature:−40°c to +105°c

Contact Material:Brass
Contact Plating:Au or Sn Over Ni
Insulator Material:Polyester(UL94V−0)
Standard: PA6T
Max.Processing Temp: 230°C for 30−60 seconds
(260°C for 10 seconds)

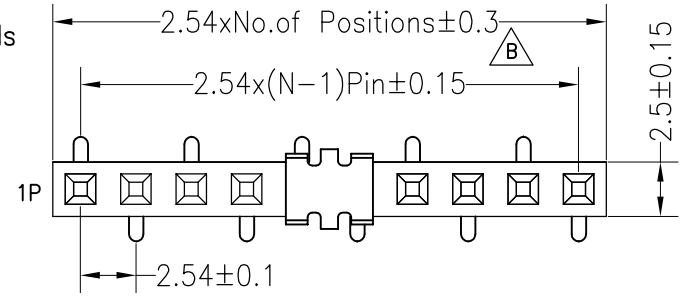


TYPE01

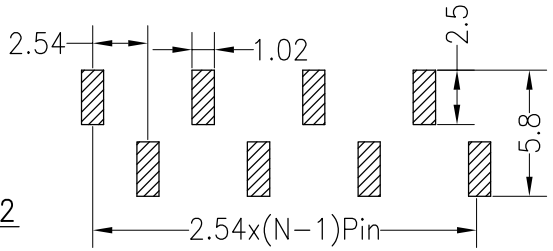
Recommended P.C.B Layout(Top Side)
(PCB BOARD TOLERANCE±0.05)



TYPE01



TYPE02

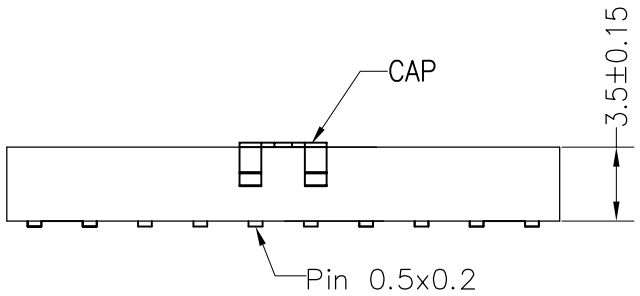


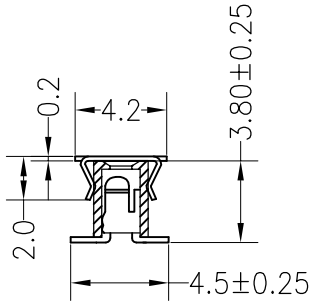
TYPE02

Ordering Information

2235 01 XX X N XX M U X 0X(1,2)

No.of Pins Per Row 1*2~1*40	Insulator Material Option	Contact Plating	Packing
	A=BK−PBT	G0:Gold Flash	T=Tube
	B=BK−PA66	G1:3U" Gold	P=Tube+Cap
	C=BK−PA6T	G2:5U" Gold	R=Reel+Cap
	D=BK−PA46	G3:10U" Gold	M=Reel+Mylar
	E=BK−PA9T	G4:15U" Gold	
	F=BK−LCP	G5:30U" Gold	
		S0:Gold Flash/Tin	
		SN:Tin	





REV	DATE	MODIFICATION DESCRIPTION	CHANGE
B	2015.05.19	Change Plastic Length:2.54xNpin+0.4 → 2.54xNpin	
A0	2012.03.28	NEW DRAWING	

OPERATION		DRAW	Liu Miao	15.05.19
X.X	±0.30			
X.XX	±0.20	CHECK		
X.XXX	±0.10			
Angle	±3°	APPROVE		
DIM	TOL			

SCALE	FIT
UNIT	mm
SIZE	A4
SHEET	1/1
PROJ.	

WFD CONN 深圳市旺富达电子有限公司 SHEN ZHEN WFD ELECTRONICS CO., LTD

PART NO.	223501XXXNXXMUX0X(1,2)
TITLE:	2.54PF H3.5mm 1xNpin SMT